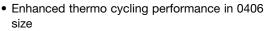


Long Side Termination Thick Film Chip Resistors



FEATURES

- Enhanced power rating
- · Long side terminations





- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- AEC-Q200 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

STANDARD	STANDARD ELECTRICAL SPECIFICATIONS									
MODEL	CASE SIZE INCH	CASE SIZE METRIC	POWER RATING P ₇₀ W	LIMITING ELEMENT VOLTAGE U _{max.} AC _{RMS} /DC V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE	RESISTANCE RANGE Ω	SERIES		
	0406	RR 1016M	0.25	50	± 100	± 1	1R0 to 1M	E24; E96		
RCL0406 e3	0406				± 200	± 5	THO TO TIVE	E24		
	Zero-Ohm-l	Resistor: R _{max}	$= 10 \text{ m}\Omega, I$	_{max.} at 70°C =	4.0 A					
	0612	RR 1632M	0.5	75	± 100	± 1	1R0 to 1M	E24; E96		
RCL0612 e3					± 200	± 5	THO TO TWI	E24		
	Zero-Ohm-Resistor: $R_{\text{max.}} = 10 \text{ m}\Omega$, $I_{\text{max.}}$ at $70^{\circ}\text{C} = 6.0 \text{ A}$									
	1218	RR 3246M	1.0	200	± 100	± 1	1R0 to 2.2M	E24; E96		
RCL1218 e3					± 200	± 5	1H0 t0 2.2W	E24		
	Zero-Ohm-l	Resistor: R _{max}	$= 20 \text{ m}\Omega, I$	_{max.} at 70°C =	7.0 A			•		
RCL1225 e3	1225 RF	RR 3263M	2.0 (1)	200	± 100	± 1	1R0 to 1M	E24; E96		
		1111 0200101			± 200	± 5	1110 10 1101	E24		
	Zero-Ohm-Resistor: $R_{\text{max.}} = 10 \text{ m}\Omega$, $I_{\text{max.}}$ at $70^{\circ}\text{C} = 12 \text{ A}$									

Notes

- These resistors do not feature a lifetime limitation when operated within the limits of rated dissipation, permissible operating voltage and
 permissible film temperature. However, the resistance typically increases due to the resistor's film temperature over operating time, generally
 known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional lifetime.
- Marking and packaging: See datasheet "Surface Mount Resistor Marking" (<u>www.vishay.com/doc?20020</u>). No marking for 0406 size.
- · Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
- (1) Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

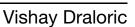
TECHNICAL SPECIFICATIONS								
PARAMETER	UNIT	RCL0406	RCL0612	RCL1218	RCL1225			
Rated Dissipation at P ₇₀ (2)	W	0.25	0.5	1.0	2.0 ⁽³⁾			
Operating Voltage U _{max.} AC _{RMS} /DC	V	50	75	200	200			
Insulation Voltage U _{ins} (1 min)	V	100	100	300	300			
Insulation Resistance	Ω	> 10 ⁹						
Operating Temperature Range	°C	- 55 to + 155						
Weight	mg	3.5	11	29.5	55			

Notes

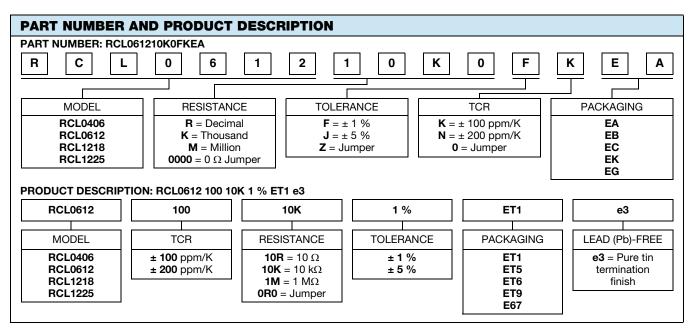
Revision: 15-Apr-13

⁽²⁾ The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

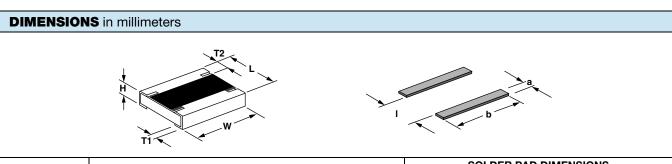
⁽³⁾ Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.







PACKAGING								
MODEL	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER		
RCL0406	EA = ET1	5000		8 mm	4 mm	180 mm/7"		
	EB = ET5	10 000				285 mm/11.25"		
	EC = ET6	20 000	Paper tape acc. to IEC 60068-3			330 mm/13"		
	EA = ET1	5000	Type I		4 mm	180 mm/7"		
RCL0612	EB = ET5	10 000				285 mm/11.25"		
	EC = ET6	20 000				330 mm/13"		
RCL1218	EK = ET9	4000	Blister tape acc. to IEC 60068-3	12 mm	4 mm	180 mm/7"		
RCL1225	EG = E67	2000	Type II	12 mm	8 mm	180 mm/7"		

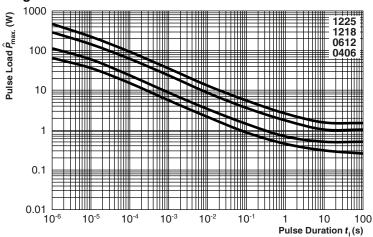


	SIZE DIMENSIONS					SOLDER PAD DIMENSIONS						
3)IZE	DIMENSIONS					REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	Н	T1	T2	а	b	I	а	b	I
0406	1016	1.0 ± 0.1	1.6 ± 0.1	0.25 ± 0.1	0.2 ^{+ 0.10} - 0.15	0.2 ± 0.1	0.55	1.75	0.35	0.75	1.8	0.35
0612	1608	1.6 ± 0.2	3.2 ± 0.2	0.55 ± 0.1	0.35 ± 0.15	0.25 ± 0.15	0.6	3.2	1.0	1.1	3.2	1.0
1218	3246	3.2 ^{+ 0.10} - 0.20	4.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	1.1	4.9	1.9	1.25	4.8	1.9
1225	3263	3.2 ± 0.2	6.3 ± 0.2	0.75 ± 0.15	0.8 ± 0.2	0.4 ± 0.2	1.9	7.6	1.2	1.9	7.6	1.2



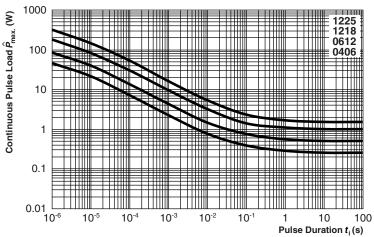
FUNCTIONAL PERFORMANCE

Single Pulse



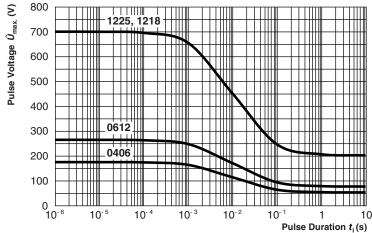
Maximum pulse load, single pulse; applicable if $\bar{P} \longrightarrow 0$ and n < 1000 and $\hat{U} \le \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Continuous Pulse



Maximum pulse load, continuous pulses; applicable if $\vec{P} \leq P$ (ϑ_{amb}) and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

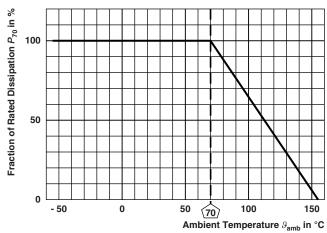
Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{\text{max.}}$; for permissible resistance change equivalent to 8000 h operation







TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)			
			Stability for product types:	STABILITY CLAS	SS 2 OR BETTER		
			RCL e3	1 Ω to	2.2 ΜΩ		
4.5	-	Resistance	-	± 1 %	± 5 %		
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	No flashover	or breakdown		
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R} \le 2 \times U_{\text{max.}};$ Duration acc. to style	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)		
447.0			Solder bath method; Sn60Pb40 non-activated flux; (235 ± 5) °C (2 ± 0.2) s	Good tinning (≥ 95 % covered) no visible damage			
4.17.2	58 (Td)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 ± 5) °C (3 ± 0.3) s	Good tinning (≥ 95 % covered) no visible damage			
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K		
4.32	21 (Uu ₃)	Shear (adhesion)	45 N	No visible damage			
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent positio \pm (0.25 % R + 0.05 Ω)			
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles	± (0.25 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)		





TEST PR	OCEDUR	RES AND REQUI	REMENTS			
EN 60115-1 CLAUSE	60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)		
		Stability for product types:	STABILITY CLASS 2 OR BETTER			
			RCL e3	1 Ω to	2.2 ΜΩ	
4.23	-	Climatic sequence:	-			
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h			
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle			
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	\pm (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h			
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles			
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$			
105.1			$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off;			
4.25.1	=	Endurance at 70 °C	70 °C; 1000 h	$\pm (0.5 \% R + 0.05 \Omega)$	± (2 % R + 0.1 Ω)	
			70 °C; 8000 h	± (1 % R + 0.05 Ω)	± (4 % R + 0.1 Ω)	
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)	
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s		
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R + 0.05 Ω)		
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD voltage: 1000 V	± (1 % R + 0.05 Ω)		
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage		
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible, no visible damage		
4.22	6 (Fc)	Vibration, endurance by sweeping	f = 10 Hz to 2000 Hz; x, y, z \leq 1.5 mm; A \leq 200 m/s ² ; 10 sweeps per axis	$\pm (0.25 \% R + 0.05 \Omega)$ $\pm (0.5 \% R + 0.05 \Omega)$		
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\text{max.}};$ 0.1 s on; 2.5 s off; 1000 cycles	± (1 % R + 0.05 Ω)		
4.27	-	Single pulse high voltage overload, 10 µs/700 µs	$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R}$ $\leq 2 \text{ x } U_{\text{max.};}$ 10 pulses	± (1 % R + 0.05 Ω)		

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper tapes according to IEC 60286-3.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000